

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

46. (Previously Presented) In an electronic card assembly, wherein the improvement comprises said electronic card assembly withstanding a rotating angle of greater than approximately 10° during a torque test which applies a torque of greater than approximately 1.2N-m, and wherein the electronic card assembly does not include a printed circuit board during the torque test.

47. (Previously Presented) The electronic card assembly according to claim 46, wherein said electronic card assembly can withstand a rotating angle of approximately 12° .

48. (Canceled).

49. (Currently Amended) In an electronic card assembly, wherein the improvement comprises said electronic card assembly deflecting less than approximately 3.5mm when the PCMCIA standard during a PCMCIA bend test which applies a force of approximately 20N is applied to an end of the electronic card assembly.

50. (Currently Amended) The electronic card assembly as recited in claim 49, wherein said electronic card assembly ~~deflects less than approximately 3.5mm during said PCMCIA bend test, and wherein the electronic card assembly does not include a printed circuit board during the PMCIA bend test.~~

51. (Canceled).

52. (Currently Amended) In an electronic card assembly, wherein the improvement comprises said card displacing less than approximately 1.5mm the PCMCIA standard during a fingernail test which applieswhen a force of more than approximately 100N

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is applied to a mating seam of two halves of the electronic card assembly, and wherein the electronic card assembly does not include a printed circuit board during the fingernail test.

53. (Canceled).